

MLZ2012 type

■ CHARACTERISTICS SPECIFICATION TABLE

Type	L		Thickness	L measuring conditions		DC resistance	Isat ^{*1}	Itemp ^{*2}	Part No.
	(μH)	Tolerance	T (mm)	Frequency (MHz)	Current (mA)	(Ω)±30%	(mA)	(mA)	
Large current	1.00	±20%	0.85	10	1.0	0.10	280	900	MLZ2012A1R0WT000
	1.50	±20%	0.85	10	1.0	0.13	250	750	MLZ2012A1R5WT000
	2.20	±20%	0.85	10	1.0	0.15	210	650	MLZ2012A2R2WT000
	3.30	±20%	0.85	10	1.0	0.34	200	450	MLZ2012A3R3WT000
	4.70	±20%	0.85	2	0.1	0.30	180	500	MLZ2012M4R7WT000
	6.80	±20%	1.25	2	0.1	0.40	160	400	MLZ2012M6R8WT000
	10.0	±20%	1.25	2	0.1	0.47	150	350	MLZ2012M100WT000
	15.0	±20%	1.25	2	0.1	0.95	120	250	MLZ2012M150WT000
	22.0	±20%	1.25	2	0.1	1.25	100	220	MLZ2012P220WT000
	22.0	±20%	1.25	2	0.1	2.0	60	220	MLZ2012M220WT000
	33.0	±20%	1.25	2	0.1	2.60	55	190	MLZ2012M330WT000
Low resistance	47.0	±20%	1.25	2	0.1	3.70	50	170	MLZ2012M470WT000
	1.00	±20%	0.85	2	0.1	0.06	220	1150	MLZ2012N1R0LT000
	1.50	±20%	0.85	2	0.1	0.10	190	900	MLZ2012N1R5LT000
	2.20	±20%	0.85	2	0.1	0.12	170	800	MLZ2012N2R2LT000
	3.30	±20%	0.85	2	0.1	0.15	130	750	MLZ2012N3R3LT000
	4.70	±20%	0.85	2	0.1	0.18	130	600	MLZ2012N4R7LT000
	6.80	±20%	0.85	2	0.1	0.25	110	550	MLZ2012N6R8LT000
	10.0	±20%	1.25	2	0.1	0.30	110	500	MLZ2012N100LT000
	15.0	±20%	1.25	2	0.1	0.47	90	350	MLZ2012N150LT000
	22.0	±20%	1.25	2	0.1	0.67	70	300	MLZ2012N220LT000
	100.0	±20%	1.25	2	0.1	3.50	30	140	MLZ2012N101LT000

*1 Current assumed when inductance ratio has decreased by 50% max..

*2 Current assumed when temperature has risen to 20°C typ. (reference value). Operating temperature environment at this time: 105°C max.

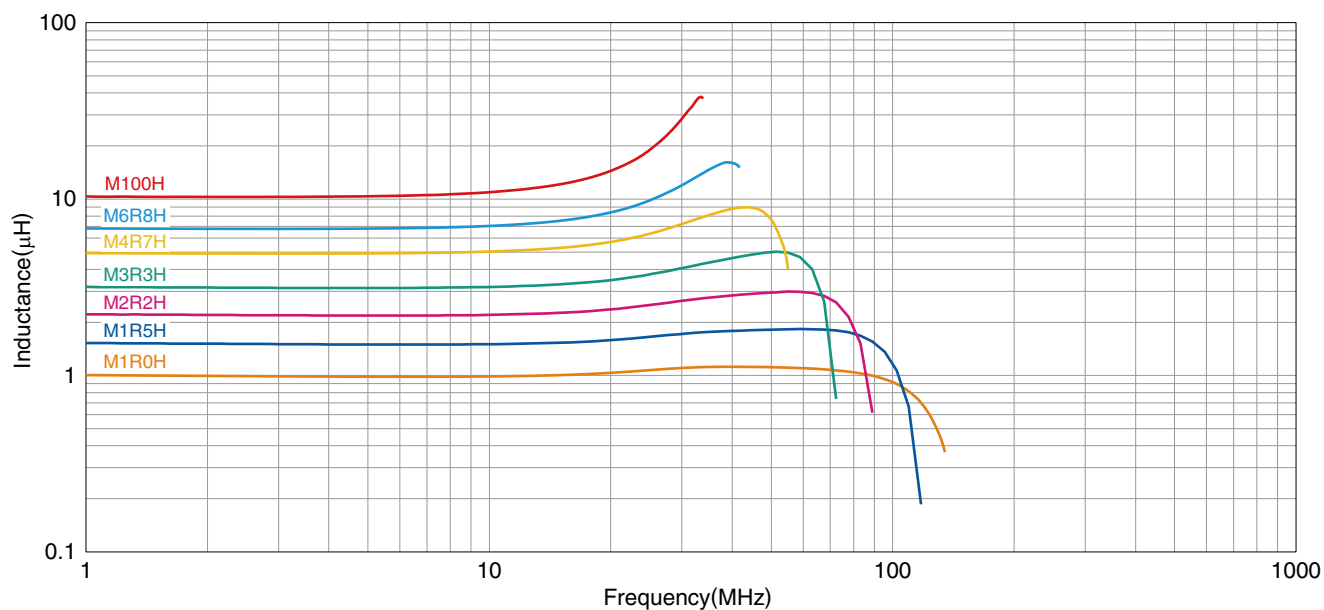
Measurement equipment

Measurement item	Product No.	Manufacturer
L	4294A+16034G	Keysight Technologies
DC resistance	Type-7561	Yokogawa

* Equivalent measurement equipment may be used.

MLZ2012 type

L FREQUENCY CHARACTERISTICS H CHARACTERISTIC PRODUCT

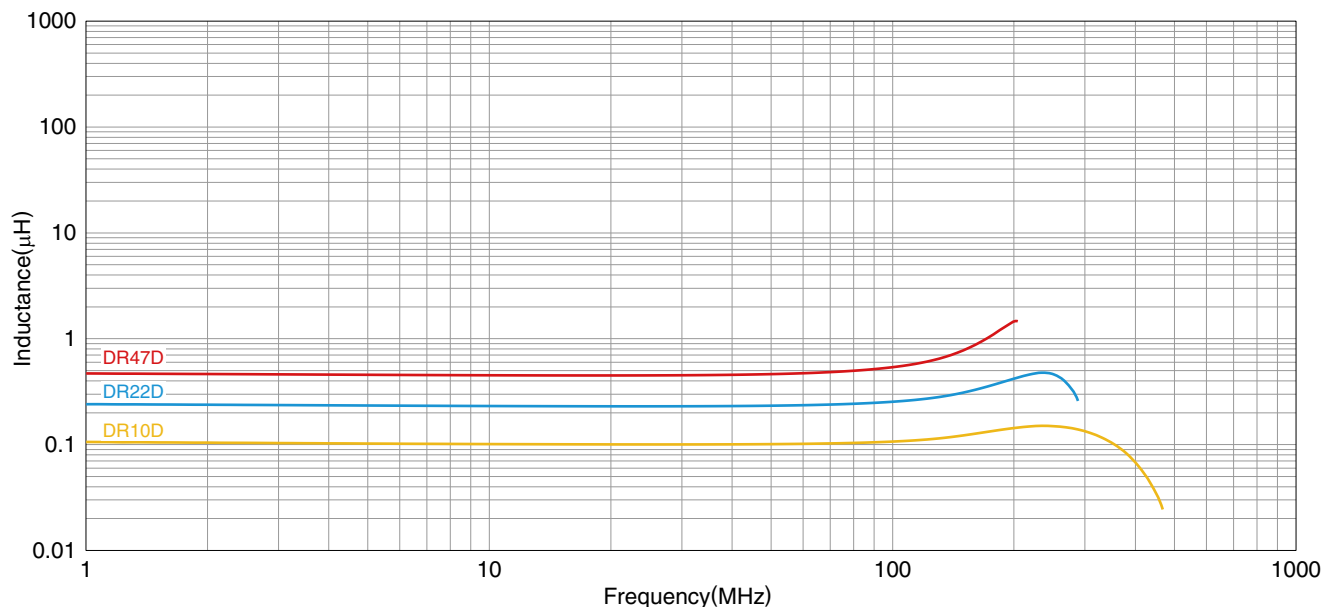


Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

L FREQUENCY CHARACTERISTICS D CHARACTERISTIC PRODUCT



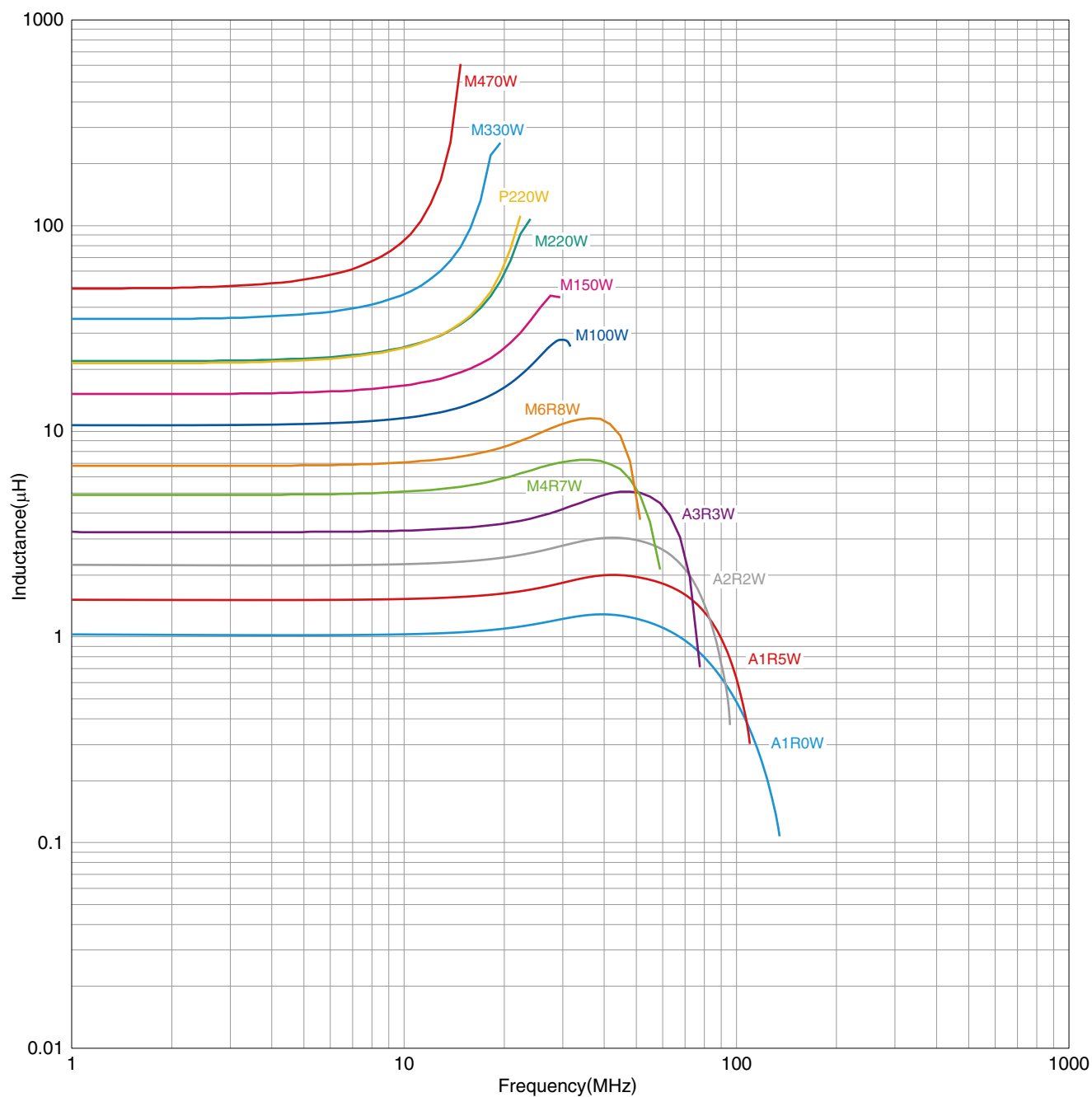
Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

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MLZ2012 type

L FREQUENCY CHARACTERISTICS W CHARACTERISTIC PRODUCT



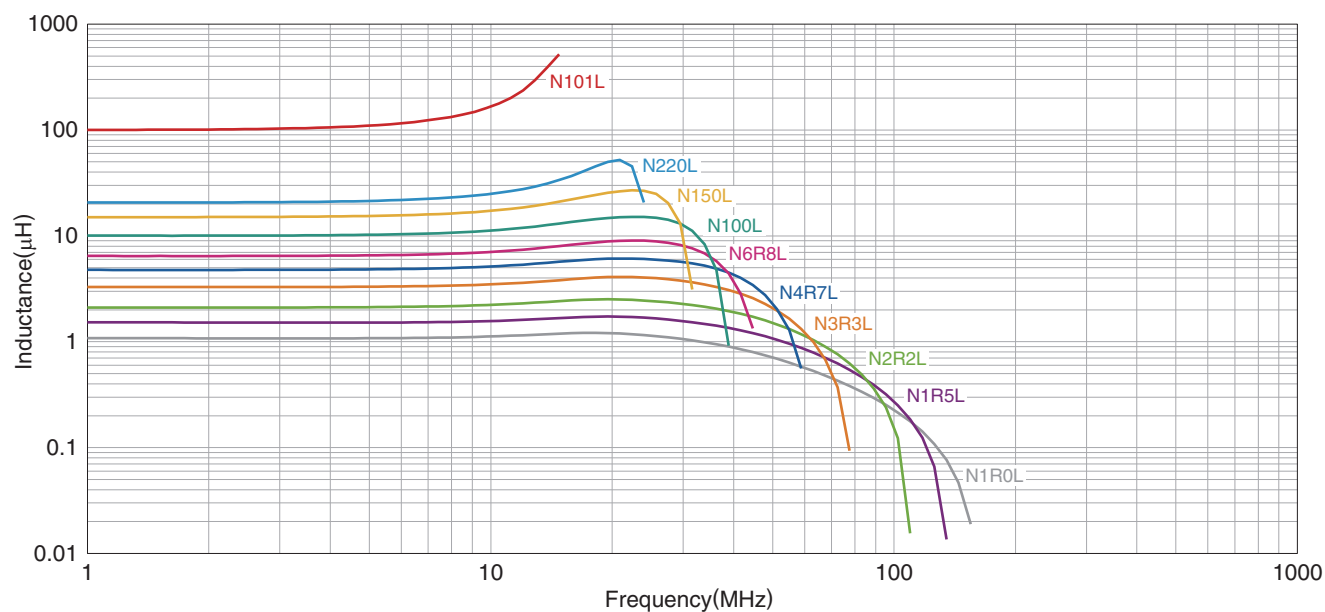
Measurement equipment

Product No.	Manufacturer
4291B+16200A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

MLZ2012 type

■ L FREQUENCY CHARACTERISTICS L CHARACTERISTIC PRODUCT



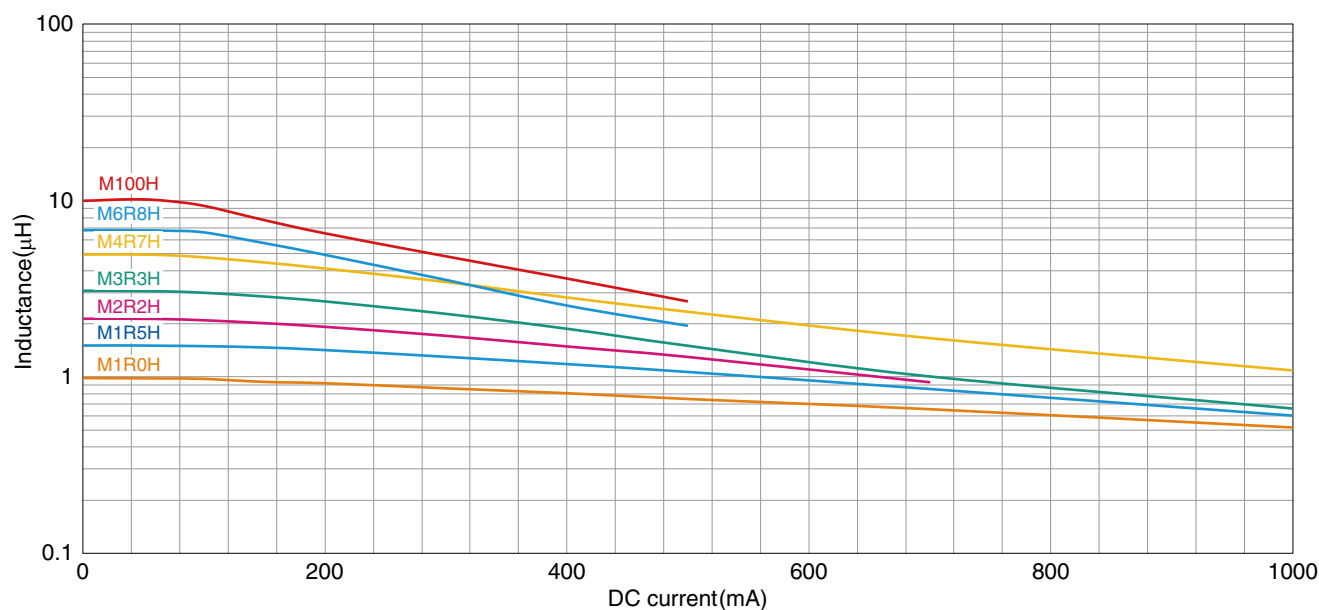
Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

MLZ2012 type

■ INDUCTANCE VS. DC BIAS CHARACTERISTICS H CHARACTERISTIC PRODUCT

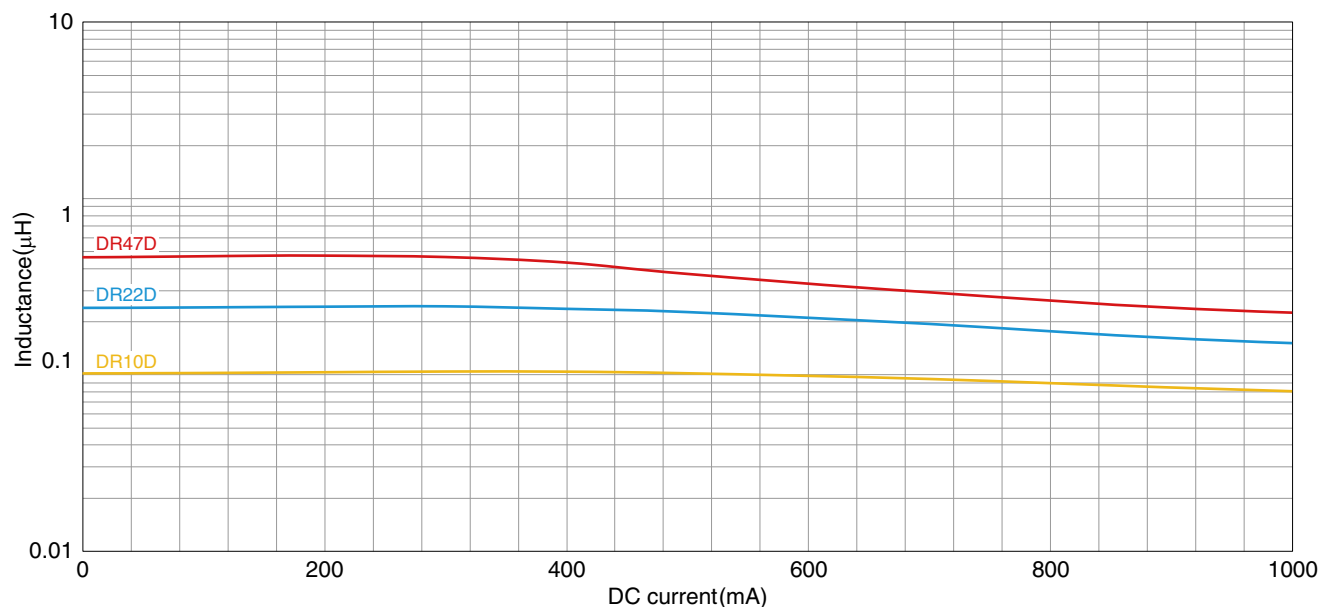


Measurement equipment

Product No.	Manufacturer
4291B+16200A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

■ INDUCTANCE VS. DC BIAS CHARACTERISTICS D CHARACTERISTIC PRODUCT



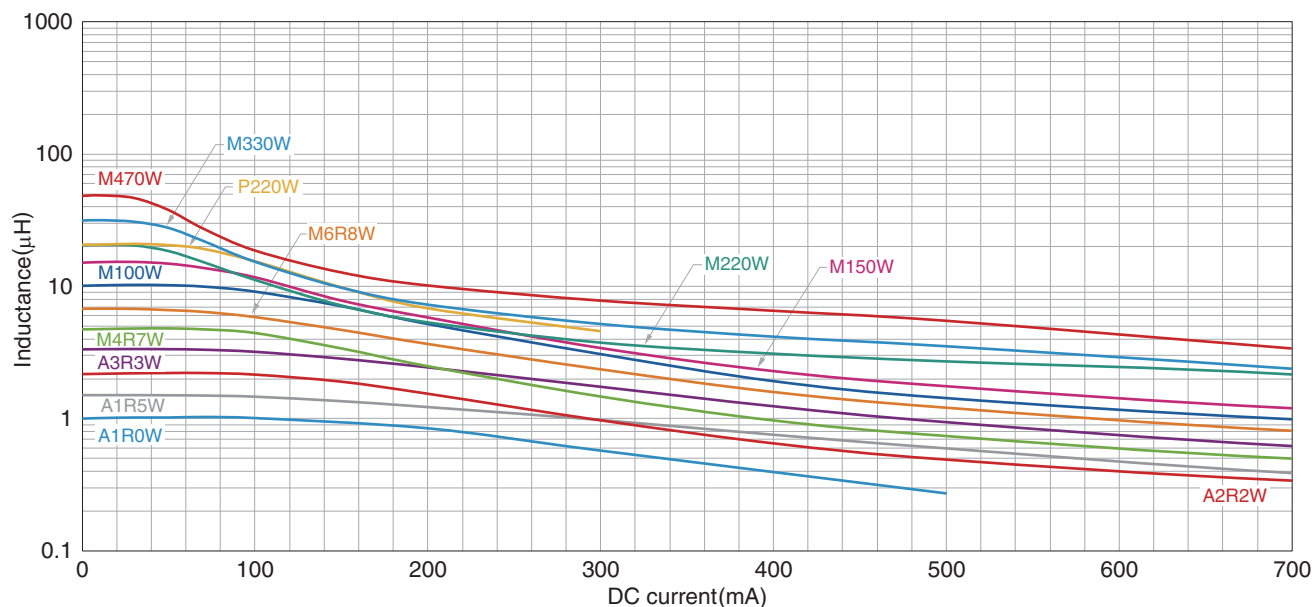
Measurement equipment

Product No.	Manufacturer
4291B+16200A+16192A	Keysight Technologies

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MLZ2012 type

■ INDUCTANCE VS. DC BIAS CHARACTERISTICS W CHARACTERISTIC PRODUCT

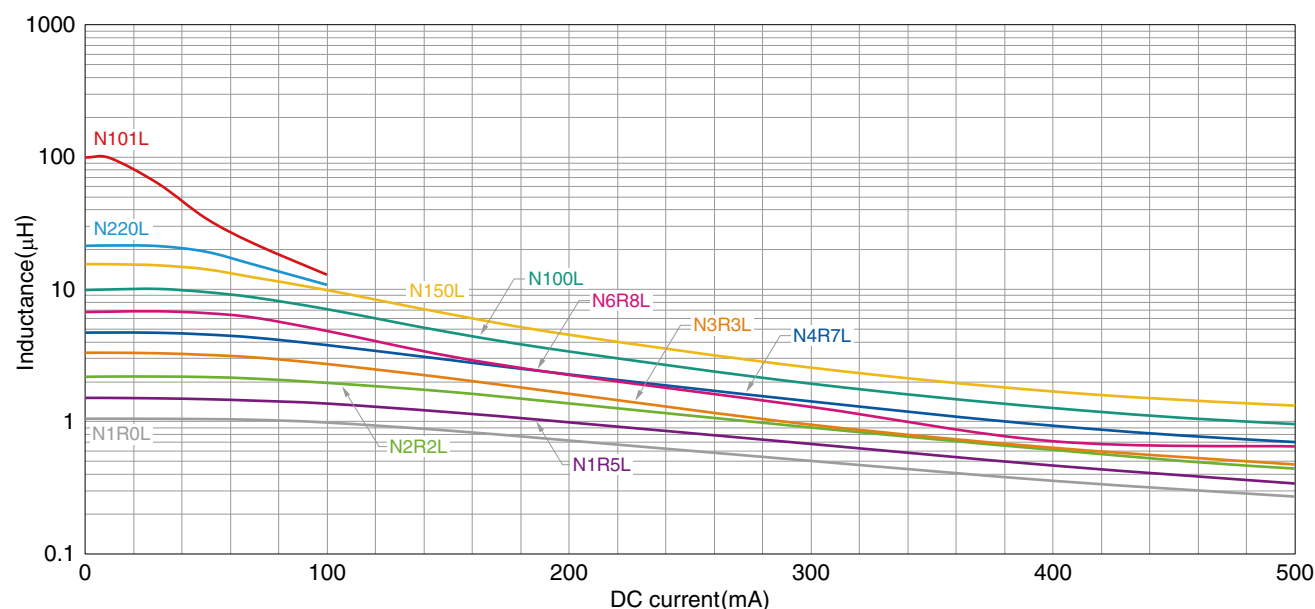


Measurement equipment

Product No.	Manufacturer
4291B+16200A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

■ INDUCTANCE VS. DC BIAS CHARACTERISTICS L CHARACTERISTIC PRODUCT



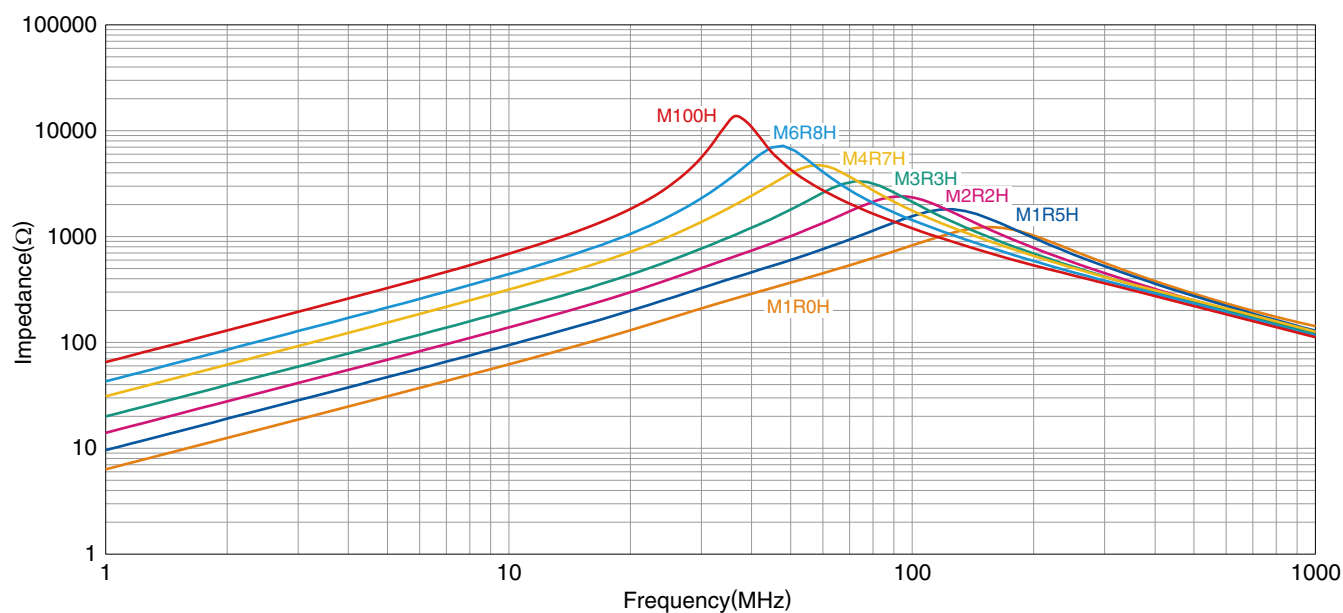
Measurement equipment

Product No.	Manufacturer
4291B+16200A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

MLZ2012 type

■ IMPEDANCE FREQUENCY CHARACTERISTICS H CHARACTERISTIC PRODUCT

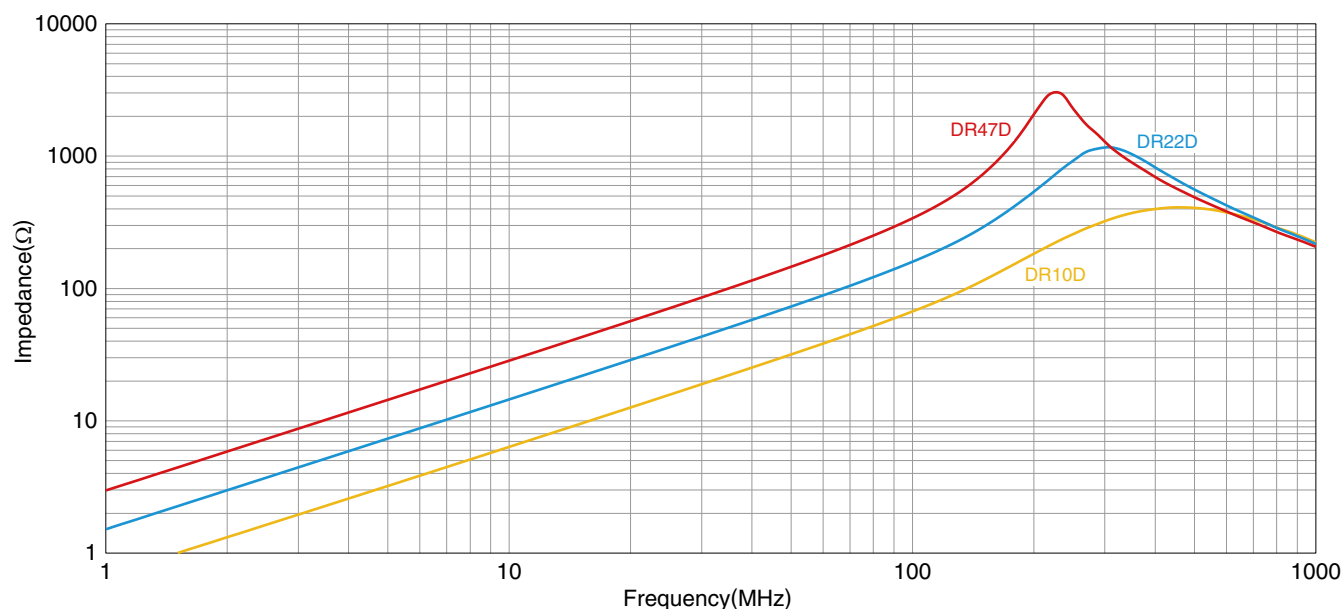


Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

■ IMPEDANCE FREQUENCY CHARACTERISTICS D CHARACTERISTIC PRODUCT



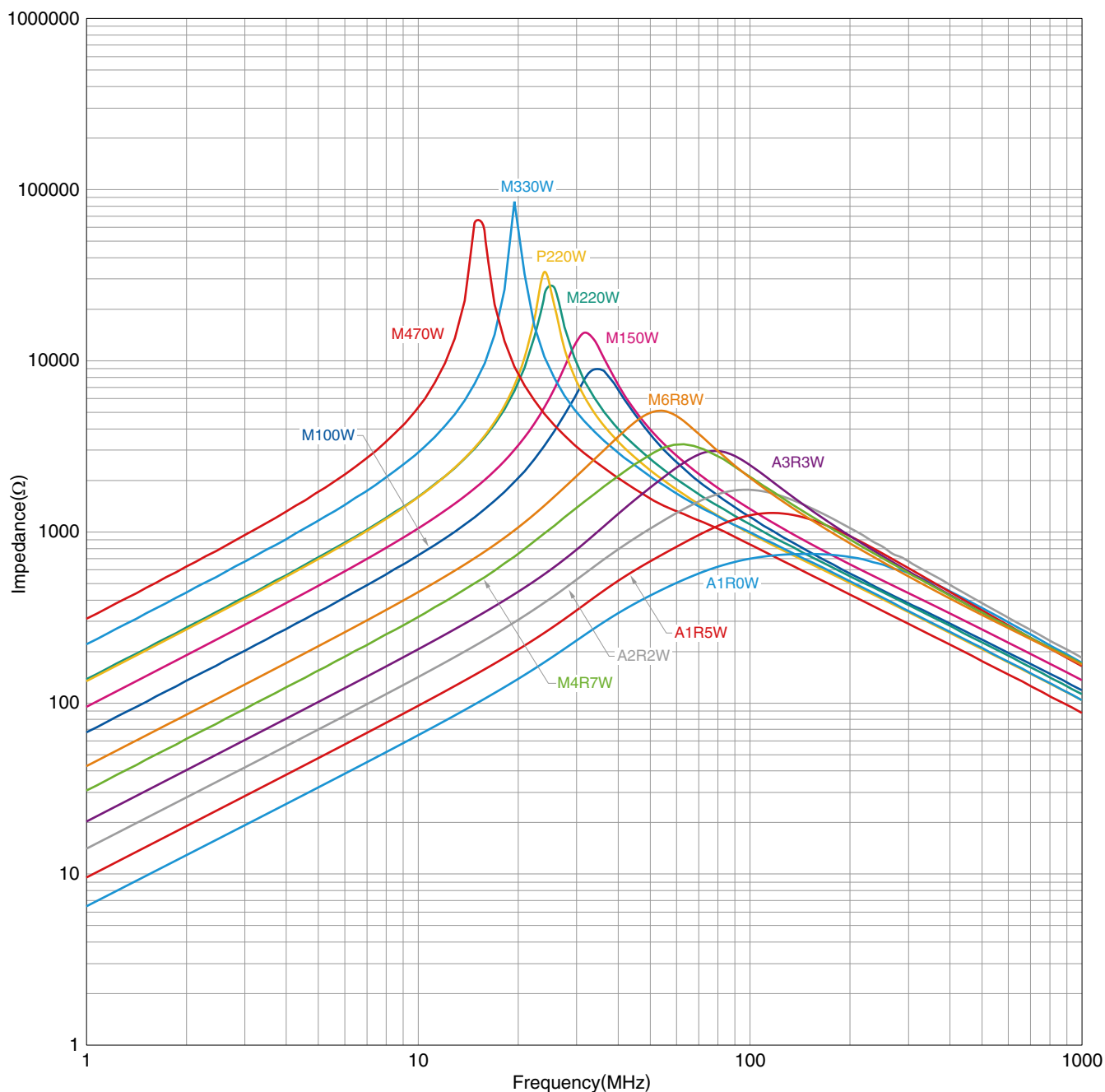
Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

MLZ2012 type

■ IMPEDANCE FREQUENCY CHARACTERISTICS W CHARACTERISTIC PRODUCT



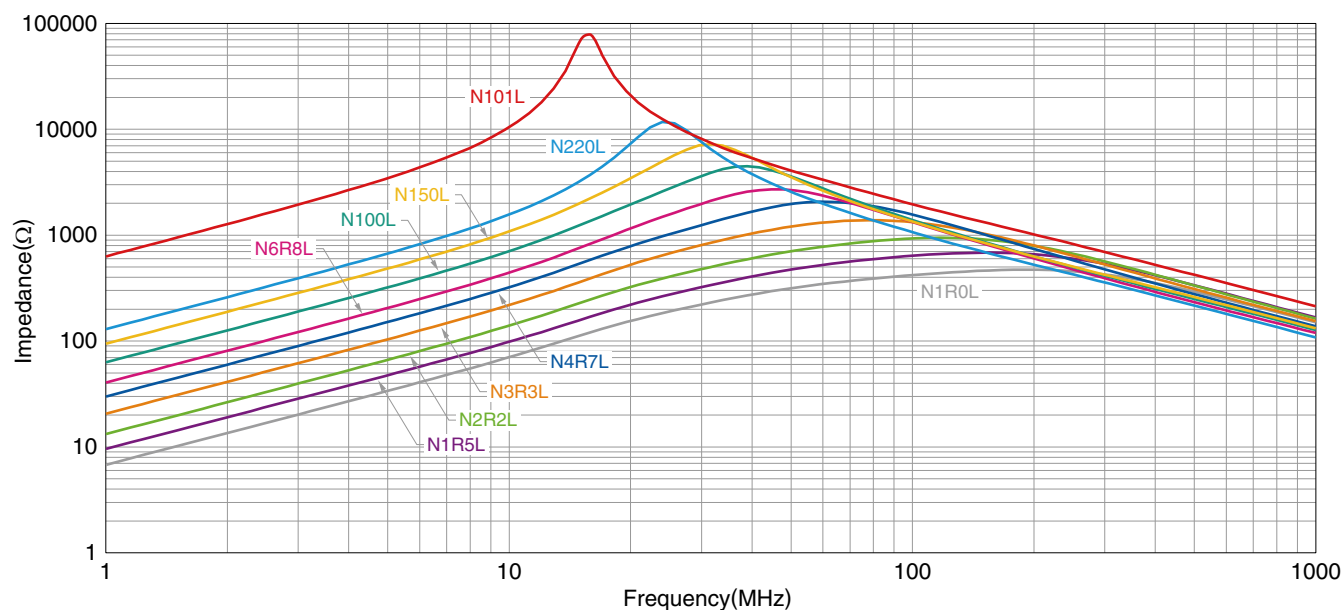
Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

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MLZ2012 type

■ IMPEDANCE FREQUENCY CHARACTERISTICS L CHARACTERISTIC PRODUCT



Measurement equipment

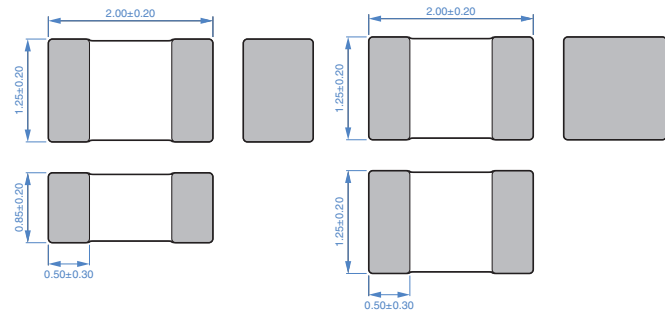
Product No.	Manufacturer
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MLZ2012 type

SHAPE & DIMENSIONS

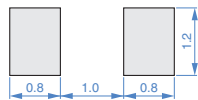
t=0.85mm



Dimensions in mm

t=1.25mm

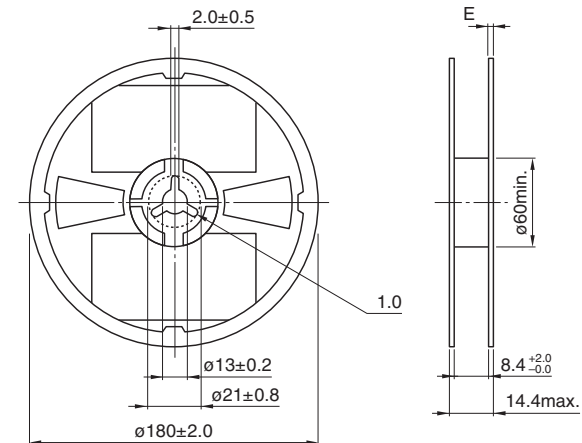
RECOMMENDED LAND PATTERN



Dimensions in mm

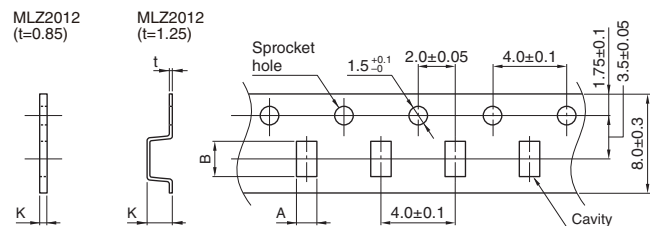
PACKAGING STYLE

REEL DIMENSIONS



Dimensions in mm

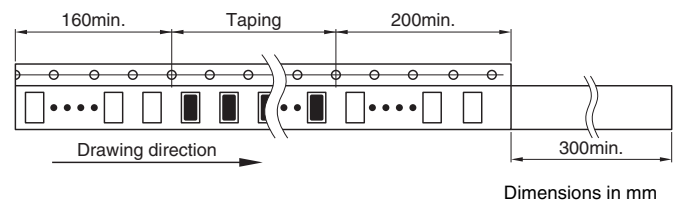
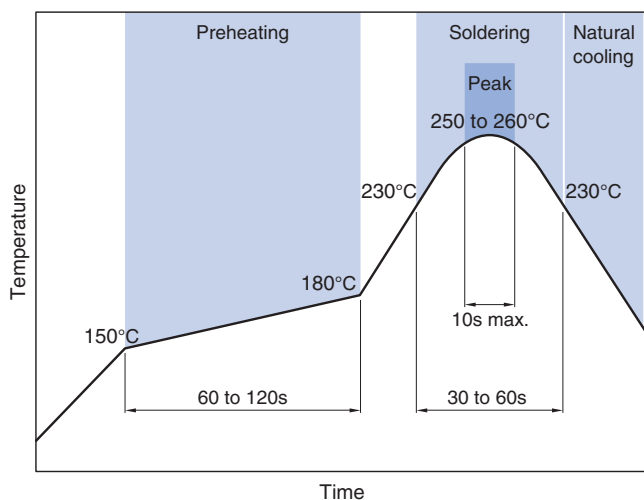
TAPE DIMENSIONS



Dimensions in mm

Type		A	B	K
MLZ2012	t=0.85	1.5±0.2	2.3±0.2	1.1 max.
	t=1.25	1.5±0.2	2.3±0.2	1.5 max.

RECOMMENDED REFLOW PROFILE



Dimensions in mm

PACKAGE QUANTITY

Package quantity	t=0.85mm	4000 pcs/reel
	t=1.25mm	2000 pcs/reel

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Type	Operating temperature range*	Storage temperature range**	Individual weight
t=0.85mm	-55 to +125 °C	-55 to +125 °C	10 mg
t=1.25mm	-55 to +125 °C	-55 to +125 °C	14 mg

* Operating temperature range includes self-temperature rise.

** The storage temperature range is for after the assembly.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

REMINDERS

- The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.